# **MC011K3VXS\*2 LDMOS TRANSISTOR**<sup>®</sup>

Document Number: MX011K3VXS Preliminary Datasheet V1.1

# 2500W, 50V High Power RF LDMOS Paired FETs

## Description

The MC011K3VXS itself is a 1300watt capable, high performance, unmatched single ended and earless LDMOS FET.

It is recommended to use paired MC011K3VXS to enable industry leading RF power up to 2500W at 50V, for ISM applications within frequencies HF to 150MHz.

Compared to equivalent dual-path packaged device, it offers better thermal management and easier maintenance, while maintaining the same size.

Demonstration of paired MC011K3VXS(right) Vs single dual-path device(left) mounted on the same design as below





• Typical performance(on 100MHz narrow band application board with **2\*MC011K3VXS** devices soldered) V<sub>DS</sub>=50V,I<sub>DQ</sub>=200mA, Pulsed CW, 10% duty cycle, 100us pulse width

| Vds | Pin(dBm) | Pout(W) | IDS(A) | Gain(dB) | Eff(%) |
|-----|----------|---------|--------|----------|--------|
| 46  | 43.53    | 2152.8  | 6.4    | 19.8     | 76     |
| 50  | 44.5     | 2570.4  | 7.03   | 19.6     | 76     |
| 55  | 44.5     | 3006.1  | 7.76   | 20.28    | 73     |

Typical performance(on 13.56MHz narrow band application board with 2\*MC011K3VXS devices soldered)

| Vds | Pin(dBm) | Pout(W) | IDS(A) | Gain(dB) | Eff(%) |
|-----|----------|---------|--------|----------|--------|
| 36  | 37       | 1222    | 20.9   | 24       | 81     |
| 40  | 37       | 1493    | 23.1   | 24.8     | 80     |
| 45  | 37       | 1905    | 25.8   | 25.8     | 82     |
| 50  | 37       | 2229    | 28.5   | 26.5     | 78     |

## Features

- High Efficiency and Linear Gain Operations
- Integrated ESD Protection
- Excellent thermal stability, low HCI drift

### **Suitable Applications**

- 30-88MHz (Ground communication)
- 54-88MHz (TV VHF I)
- 88-108MHz (FM)
- 136-174MHz (Commercial ground communication)

- Large Positive and Negative Gate/Source Voltage Range for Improved Class C Operation
- Pb-free, RoHS-compliant
- Laser Exciter
- Synchrotron
- MRI
- Plasma generator
- Weather Radar



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#### Table 1. Maximum Ratings

| Rating   |         | Symbol               |         | Value      |            |     | Unit |  |
|--|---------|----------------------|---------|------------|------------|-----|------|--|
| DrainSource Voltage  |         | V <sub>DSS</sub>     |         | +140       |            |     | Vdc  |  |
| GateSource Voltage   |         | V <sub>GS</sub>      |         | -10 to +10 |            |     | Vdc  |  |
| Operating Voltage  |         | V <sub>DD</sub>      |         |            | +55        |     | Vdc  |  |
| Storage Temperature Range  | Tstg    |                      |         | -6         | 65 to +150 |     | °C   |  |
| Case Operating Temperature   |         | Tc                   | - +150  |            |            | °C  |      |  |
| Operating Junction Temperature T   |         | T,                   | +225    |            |            |     | °C   |  |
| Table 2. Thermal Characteristics   |         |                      |         |            |            |     |      |  |
| Characteristic   |         |                      | S       | Symbol     | Value      |     | Unit |  |
| Transient thermal impedance from junction to case  |         |                      |         | 746        | 0.045      |     | 0000 |  |
| Tj = 85° C; tp = 100 us; Duty cycle = 10 %   |         |                      |         | Zin        | 0.015      |     | °C/W |  |
| Table 3. ESD Protection Characteristics  |         |                      |         |            |            | •   |      |  |
| Test Methodology   |         |                      | Class   |            |            |     |      |  |
| Human Body Model (per JESD22A114)  |         | Class 2              |         |            |            |     |      |  |
| Table 4. Electrical Characteristics (T <sub>A</sub> = 25 $^{\circ}$ C unless other the second | nerwise | noted)               |         |            |            |     |      |  |
| Characteristic   |         | Sy                   | mbol    | Min        | Тур        | Max | Unit |  |
| DC Characteristics (per half section)  |         |                      |         | •          |            | •   |      |  |
| Drain-Source Voltage   |         | V                    |         |            | 140        |     | N    |  |
| V <sub>GS</sub> =0, I <sub>DS</sub> =1.0mA   |         | V <sub>(BR)DSS</sub> |         | ;S         | 140        |     | V    |  |
| Zero Gate Voltage Drain Leakage Current  |         |                      |         |            |            | 1   |      |  |
| $(V_{DS} = 75V, V_{GS} = 0 V)$   |         |                      | DSS     |            |            | I   | μΑ   |  |
| Zero Gate Voltage Drain Leakage Current  |         |                      |         |            | 1          |     |      |  |
| (V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 0 V)  |         | IDSS                 |         |            |            | μΑ  |      |  |
| GateSource Leakage Current<br>( $V_{GS}$ = 10 V, $V_{DS}$ = 0 V)   |         | I <sub>css</sub> ——  |         |            |            | 1   |      |  |
|  |         |                      |         |            |            | μΑ  |      |  |
| Gate Threshold Voltage ( $V_{DS}$ = 50V, $I_D$ = 600 $\mu$ A)  |         |                      |         | (#b)       | 2.0        |     | V    |  |
|  |         |                      | ss(tri) |            | 2.0        |     | v    |  |
| Gate Quiescent Voltage   |         |                      |         |            | 2.06       |     | V    |  |
| (V_{DD} = 50 V, I_D = 300 mA, Measured in Functional Test)   |         | VGS                  | GS(Q)   |            | 3.00       |     | v    |  |
|  |         | = 0 1 / 1            |         |            |            |     |      |  |

Load Mismatch (In Innogration Test Fixture, 50 ohm system): V<sub>DD</sub> = 50 Vdc, I<sub>DQ</sub> = 300 mA, f = 100MHz, pulse width:100us, duty

cycle:10%, 2 piece of MC011K3VXS combined

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| Component                            | Description                  | Suggested    |
|--------------------------------------|------------------------------|--------------|
|                                      |                              | Manufacturer |
| C1,C7                                | 68pF                         | ATC800B      |
| C2,C3,C4,C5,C11,C12,C13,C14,C15,C16, | 1000pF                       | DLC70B       |
| C17,C18,C21,C23,C26,C27,C29,C30      |                              |              |
| C6                                   | 20pF                         | DLC70B       |
| C8,C9                                | 24pF                         | DLC70B       |
| C10,C19                              | ЗрF                          | DLC70B       |
| C20,C22,C24,C25,C28,C31              | 10uF                         | 10uF/100V    |
| C32,C33                              | 4700uF/63V                   | 4700uF/63V   |
| R1,R2                                | Chip Resistor,200ohm         | 1206         |
| R3,R4                                | Chip Resistor,10ohm          | 1206         |
| Т1                                   | 50ohm,Line length=135mm      | SF-086-50    |
| T2,T3                                | 25ohm,Line length=135mm      | SF-086-25    |
| T4,T5                                | 12.5ohm,Line length=135mm    | SFF-12.5-3   |
| Тб                                   | 17ohm,Line length=170mm      | SFF-17-1.5   |
| L1,L2                                | 6 turns, Inside diameter 5mm |              |

Table 5. Test Circuit Component Designations and Values

## **TYPICAL CHARACTERISTICS**

Figure 1: Pulsed CW Gain and Power Efficiency as a Function of Pout @100MHz at 55V



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| Part           | description                    | Model                          |  |
|----------------|--------------------------------|--------------------------------|--|
| C1,C2,C3,C4,C5 | 10uF/100V                      | Ceramic multilayer capacitor   |  |
| C6~C14         | 10nF                           | Ceramic multilayer capacitor   |  |
| C15,C16        | 4700uF                         | 63V/4700uF                     |  |
| R1             | <b>360</b> Ω                   | Plug-in electric resistance    |  |
| R2,R3          | <b>220</b> Ω* <b>4</b> 并联      | Chip Resistor                  |  |
| R4,R5          | <b>186</b> Ω功率电阻               |                                |  |
| T1             | T1 4:1                         |                                |  |
| T2             | 12.5ohm/450mm                  | FT-50-43                       |  |
| Т3             | 12.5ohm/300mm                  | RF-800-1708                    |  |
| L1, L2         | 35turns,绕径 5mm 线径 1.5mm        | DIY air core inductance        |  |
| PCB            | 0.762mm [0.030″] thick, εr=3.5 | i0, Rogers 4350B, 1 oz. copper |  |

#### Table 6. Test Circuit Component Designations and Values

## **TYPICAL CHARACTERISTICS**



Figure 2: Pulsed CW Gain and Power Efficiency as a Function of Pout @13.56MHz at 50V

# Package Outline



## **Revision history**

#### Table 5. Document revision history

| Date      | Revision | Datasheet Status                                       |
|-----------|----------|--|
| 2021/6/25 | Rev 1.0  | Advanced datasheet                                     |
| 2022/4/12 | Rev 1.1  | Preliminary datasheet according to 13.56MHz data added |
|           |          | Modify some words on 1 <sup>st</sup> page              |

Application data based on ZL-21-16/HL-22-18

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